



# BCP56H series

80 V, 1 A NPN medium power transistors

Rev. 1 — 23 November 2016

Product data sheet

## 1. Product profile

### 1.1 General description

NPN medium power transistors in a medium power SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

| Type number | Package  |       |       | PNP complement |
|-------------|----------|-------|-------|----------------|
|             | Nexperia | JEITA | JEDEC |                |
| BCP56H      | SOT223   | SC-73 | -     | BCP53H         |
| BCP56-10H   |          |       |       | BCP53-10H      |
| BCP56-16H   |          |       |       | BCP53-16H      |

### 1.2 Features and benefits

- High collector current capability  $I_C$  and  $I_{CM}$
- Three current gain selections
- High power dissipation capability
- High-temperature applications up to 175 °C
- AEC-Q101 qualified

### 1.3 Applications

- Linear voltage regulators
- MOSFET drivers
- Low-side switches
- Power management
- Amplifiers

### 1.4 Quick reference data

Table 2. Quick reference data

$T_{amb} = 25\text{ °C}$  unless otherwise specified.

| Symbol    | Parameter                 | Conditions                           | Min | Typ | Max | Unit |
|-----------|---------------------------|--------------------------------------|-----|-----|-----|------|
| $V_{CEO}$ | collector-emitter voltage | open base                            | -   | -   | 80  | V    |
| $I_C$     | collector current         |                                      | -   | -   | 1   | A    |
| $I_{CM}$  | peak collector current    | single pulse; $t_p \leq 1\text{ ms}$ | -   | -   | 2   | A    |

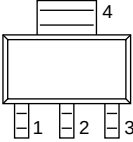
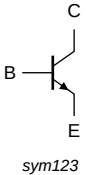
Table 2. Quick reference data ...continued  
*T<sub>amb</sub> = 25 °C unless otherwise specified.*

| Symbol          | Parameter       | Conditions                                                         | Min | Typ | Max | Unit |
|-----------------|-----------------|--------------------------------------------------------------------|-----|-----|-----|------|
| h <sub>FE</sub> | DC current gain | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 150 mA <a href="#">[1]</a> | 63  | -   | 250 |      |
|                 | BCP56-10H       | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 150 mA <a href="#">[1]</a> | 63  | -   | 160 |      |
|                 | BCP56-16H       | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 150 mA <a href="#">[1]</a> | 100 | -   | 250 |      |

[1] Pulse test: t<sub>p</sub> ≤ 300 μs; δ = 0.02

2. Pinning information

Table 3. Pinning

| Pin | Symbol | Description | Simplified outline                                                                  | Graphic symbol                                                                      |
|-----|--------|-------------|-------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| 1   | B      | base        |  |  |
| 2   | C      | collector   |                                                                                     |                                                                                     |
| 3   | E      | emitter     |                                                                                     |                                                                                     |
| 4   | C      | collector   |                                                                                     |                                                                                     |

3. Ordering information

Table 4. Ordering information

| Type number | Package |                                                                  |         |
|-------------|---------|------------------------------------------------------------------|---------|
|             | Name    | Description                                                      | Version |
| BCP56H      | SC-73   | plastic surface-mounted package with increased heatsink; 4 leads | SOT223  |
| BCP56-10H   |         |                                                                  |         |
| BCP56-16H   |         |                                                                  |         |

4. Marking

Table 5. Marking codes

| Type number | Marking code |
|-------------|--------------|
| BCP56H      | BCP56H       |
| BCP56-10H   | P5610H       |
| BCP56-16H   | P5616H       |

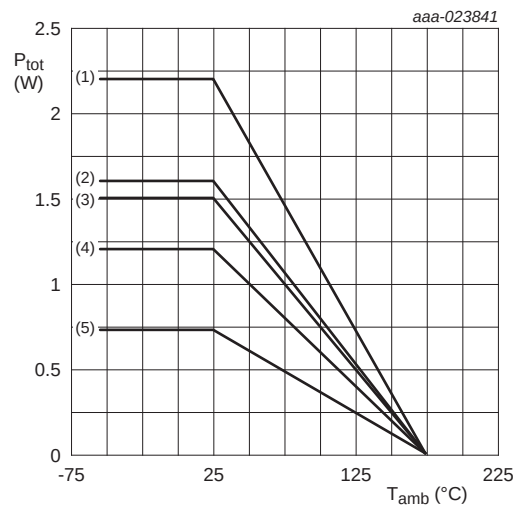
## 5. Limiting values

**Table 6. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

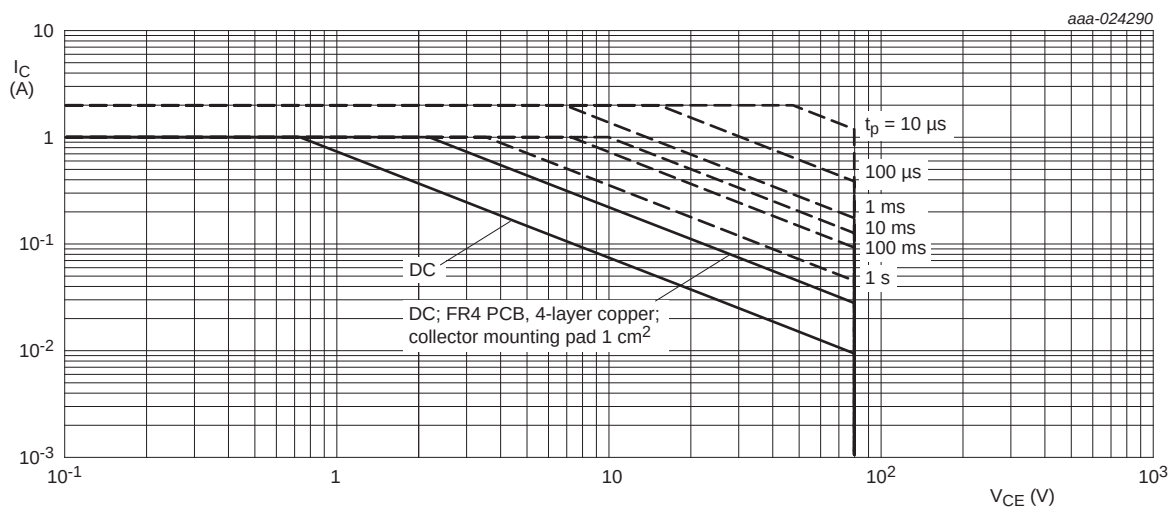
| Symbol    | Parameter                 | Conditions                       | Min | Max  | Unit   |
|-----------|---------------------------|----------------------------------|-----|------|--------|
| $V_{CBO}$ | collector-base voltage    | open emitter                     | -   | 100  | V      |
| $V_{CEO}$ | collector-emitter voltage | open base                        | -   | 80   | V      |
| $V_{EBO}$ | emitter-base voltage      | open collector                   | -   | 7    | V      |
| $I_C$     | collector current         |                                  | -   | 1    | A      |
| $I_{CM}$  | peak collector current    | single pulse;<br>$t_p \leq 1$ ms | -   | 2    | A      |
| $I_B$     | base current              |                                  | -   | 0.2  | A      |
| $I_{BM}$  | peak base current         | single pulse;<br>$t_p \leq 1$ ms | -   | 0.3  | A      |
| $P_{tot}$ | total power dissipation   | $T_{amb} \leq 25$ °C             | [1] | -    | 725 mW |
|           |                           |                                  | [2] | -    | 1.2 W  |
|           |                           |                                  | [3] | -    | 1.5 W  |
|           |                           |                                  | [4] | -    | 1.6 W  |
|           |                           |                                  | [5] | -    | 2.2 W  |
| $T_j$     | junction temperature      |                                  | -   | +175 | °C     |
| $T_{amb}$ | ambient temperature       |                                  | -55 | +175 | °C     |
| $T_{stg}$ | storage temperature       |                                  | -65 | +175 | °C     |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- [4] Device mounted on an FR4 PCB, 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB, 4-layer copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



- (1) FR4 PCB, 4-layer copper, 1 cm<sup>2</sup>
- (2) FR4 PCB, 4-layer copper, standard footprint
- (3) FR4 PCB, single-sided copper, 6 cm<sup>2</sup>
- (4) FR4 PCB, single-sided copper, 1 cm<sup>2</sup>
- (5) FR4 PCB, single-sided copper, standard footprint

**Fig 1. Power derating curves**



Unless otherwise specified:

$T_{amb} = 25\text{ °C}$

Single pulse

FR4 PCB, single-sided copper; standard footprint

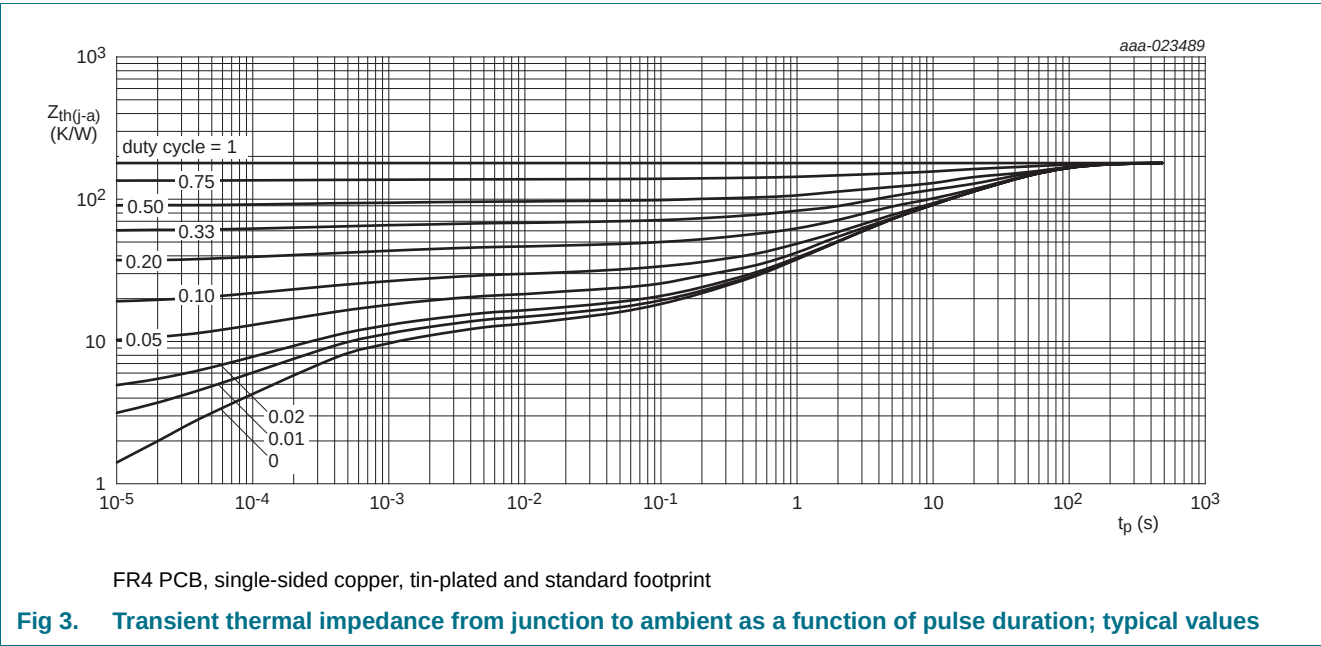
**Fig 2. Safe operating area; junction to ambient; continuous and peak collector currents as a function of collector-emitter voltage**

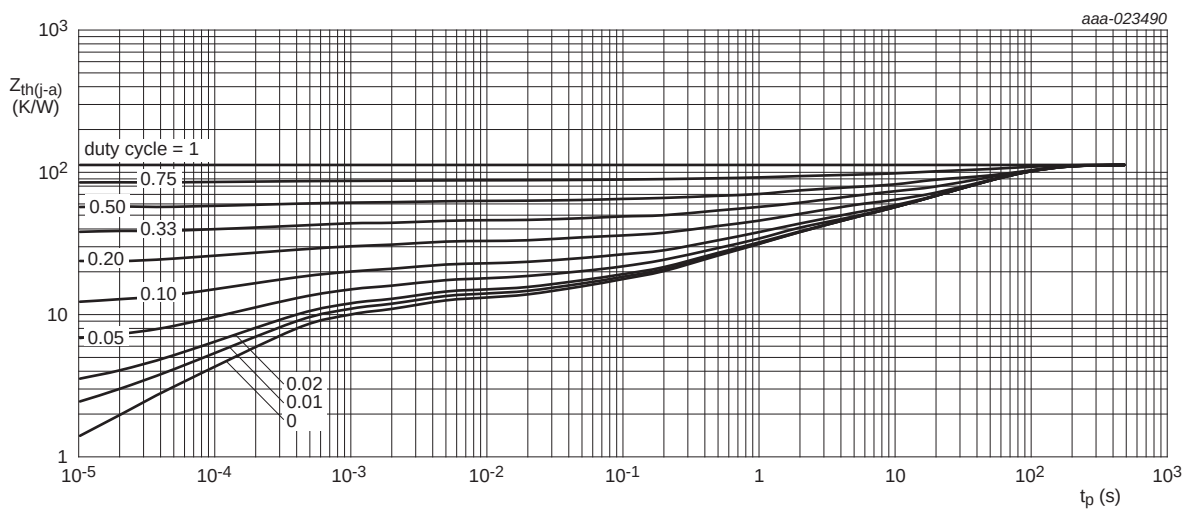
6. Thermal characteristics

Table 7. Thermal characteristics

| Symbol                | Parameter                                        | Conditions  | Min                 | Typ | Max | Unit |     |
|-----------------------|--------------------------------------------------|-------------|---------------------|-----|-----|------|-----|
| R <sub>th(j-a)</sub>  | thermal resistance from junction to ambient      | in free air | <a href="#">[1]</a> | -   | -   | 207  | K/W |
|                       |                                                  |             | <a href="#">[2]</a> | -   | -   | 125  | K/W |
|                       |                                                  |             | <a href="#">[3]</a> | -   | -   | 100  | K/W |
|                       |                                                  |             | <a href="#">[4]</a> | -   | -   | 94   | K/W |
|                       |                                                  |             | <a href="#">[5]</a> | -   | -   | 69   | K/W |
| R <sub>th(j-sp)</sub> | thermal resistance from junction to solder point |             | -                   | -   | 18  | K/W  |     |

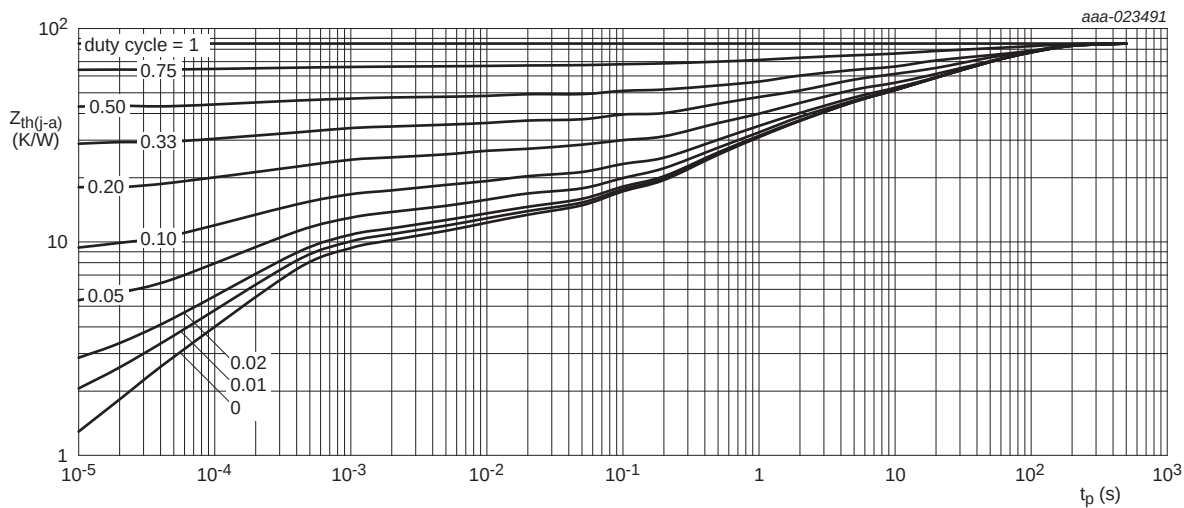
- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- [4] Device mounted on an FR4 PCB, 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB, 4-layer copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.





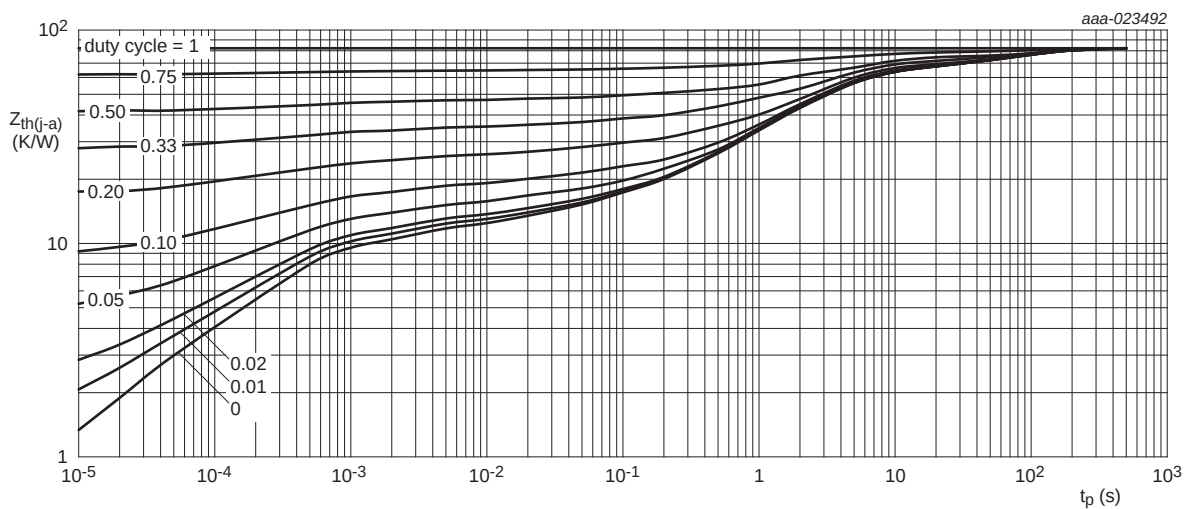
FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>

Fig 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



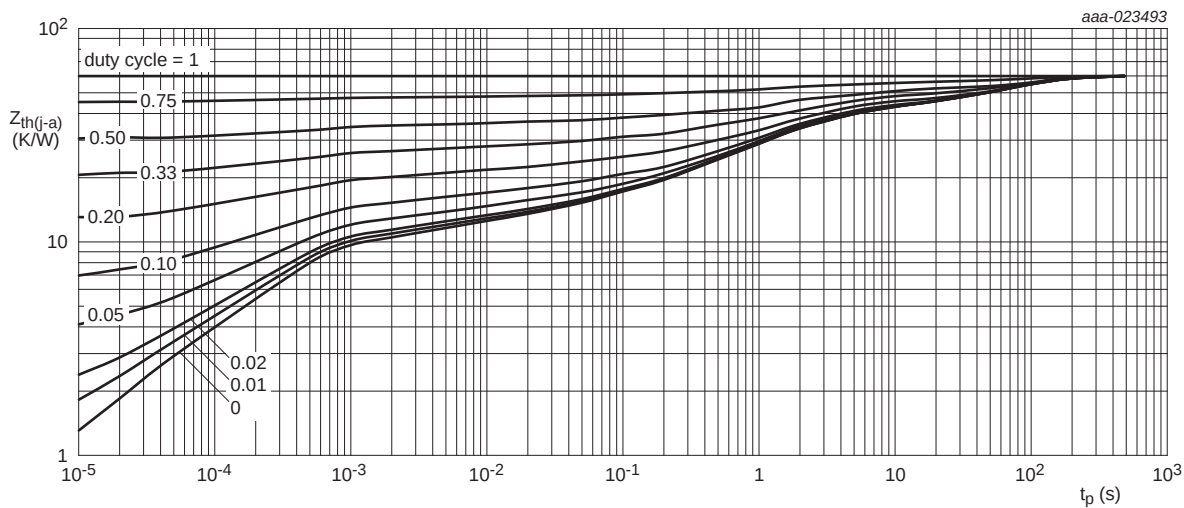
FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 6 cm<sup>2</sup>

Fig 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, tin-plated and standard footprint.

Fig 6. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>

Fig 7. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

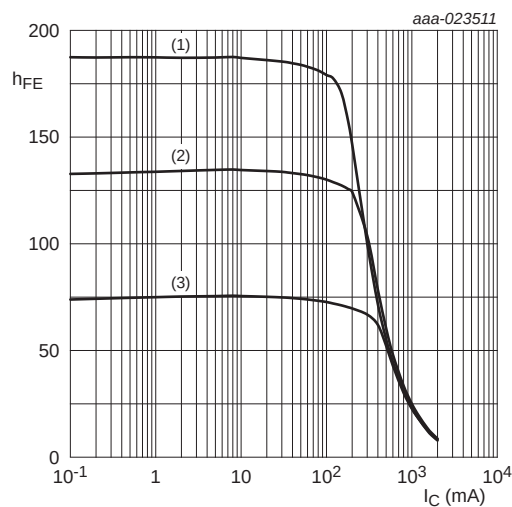
## 7. Characteristics

**Table 8. Characteristics**

$T_{amb} = 25\text{ °C}$  unless otherwise specified.

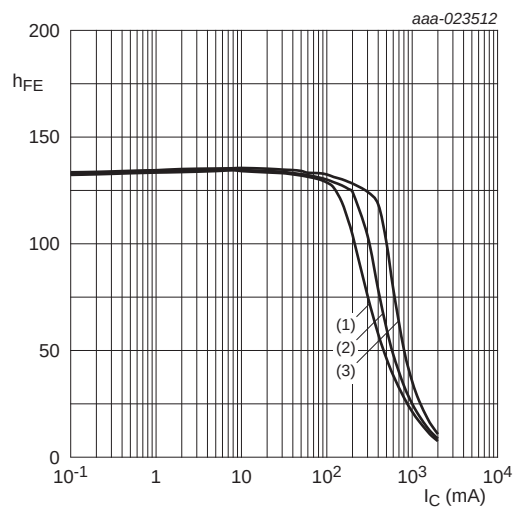
| Symbol      | Parameter                            | Conditions                                                            | Min | Typ | Max | Unit          |
|-------------|--------------------------------------|-----------------------------------------------------------------------|-----|-----|-----|---------------|
| $I_{CBO}$   | collector-base cut-off current       | $V_{CB} = 30\text{ V}; I_E = 0\text{ A}$                              | -   | -   | 100 | nA            |
|             |                                      | $V_{CB} = 30\text{ V}; I_E = 0\text{ A}; T_j = 150\text{ °C}$         | -   | -   | 10  | $\mu\text{A}$ |
| $I_{EBO}$   | emitter-base cut-off current         | $V_{EB} = 5\text{ V}; I_C = 0\text{ A}$                               | -   | -   | 100 | nA            |
| $h_{FE}$    | DC current gain                      | $V_{CE} = 2\text{ V}; I_C = 5\text{ mA}$                              | 63  | -   | -   |               |
|             |                                      | $V_{CE} = 2\text{ V}; I_C = 150\text{ mA}$ [1]                        | 63  | -   | 250 |               |
|             |                                      | $V_{CE} = 2\text{ V}; I_C = 500\text{ mA}$ [1]                        | 40  | -   | -   |               |
|             | BCP56-10T                            | $V_{CE} = 2\text{ V}; I_C = 150\text{ mA}$ [1]                        | 63  | -   | 160 |               |
|             | BCP56-16T                            | $V_{CE} = 2\text{ V}; I_C = 150\text{ mA}$ [1]                        | 100 | -   | 250 |               |
| $V_{CEsat}$ | collector-emitter saturation voltage | $I_C = 500\text{ mA}; I_B = 50\text{ mA}$ [1]                         | -   | -   | 500 | mV            |
| $V_{BE}$    | base-emitter voltage                 | $V_{CE} = 2\text{ V}; I_C = 500\text{ mA}$ [1]                        | -   | -   | 1   | V             |
| $f_T$       | transition frequency                 | $V_{CE} = 5\text{ V}; I_C = 50\text{ mA};$<br>$f = 100\text{ MHz}$    | 100 | 155 | -   | MHz           |
| $C_C$       | collector capacitance                | $V_{CB} = 10\text{ V}; I_E = I_C = 0\text{ A};$<br>$f = 1\text{ MHz}$ | -   | 4.5 | -   | pF            |

[1] Pulse test:  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta = 0.02$



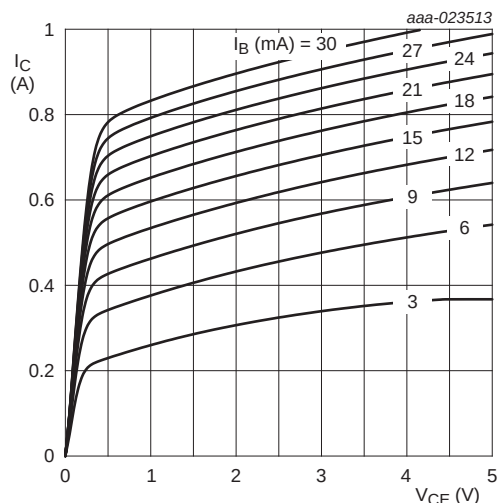
- $V_{CE} = 2$  V
- (1)  $T_{amb} = 100$  °C
  - (2)  $T_{amb} = 25$  °C
  - (3)  $T_{amb} = -55$  °C

Fig 8. DC current gain as a function of collector current; typical values



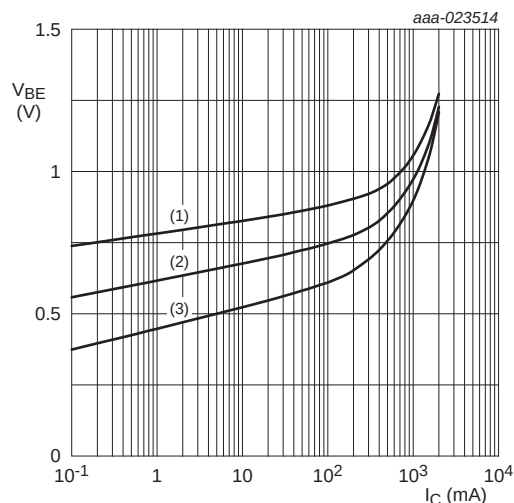
- $T_{amb} = 25$  °C
- (1)  $V_{CE} = 1$  V
  - (2)  $V_{CE} = 2$  V
  - (3)  $V_{CE} = 5$  V

Fig 9. DC current gain as a function of collector current; typical values



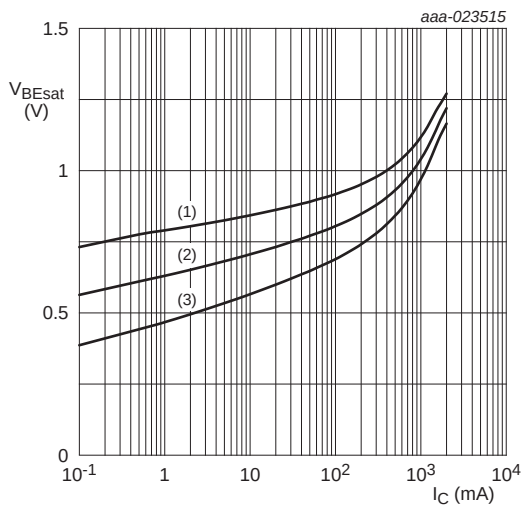
$T_{amb} = 25$  °C

Fig 10. Collector current as a function of collector-emitter voltage; typical values



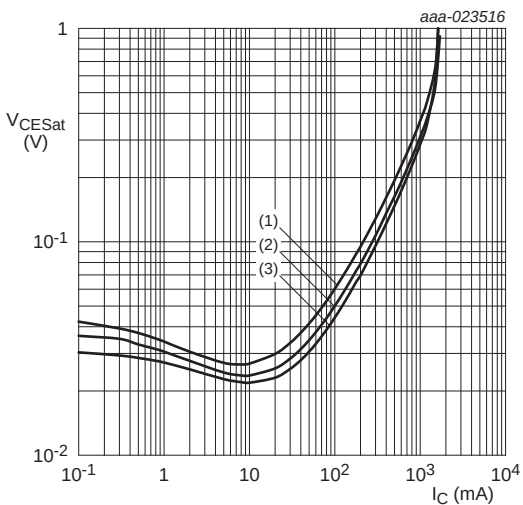
- $V_{CE} = 2$  V
- (1)  $T_{amb} = -55$  °C
  - (2)  $T_{amb} = 25$  °C
  - (3)  $T_{amb} = 100$  °C

Fig 11. Base-emitter voltage as a function of collector current; typical values



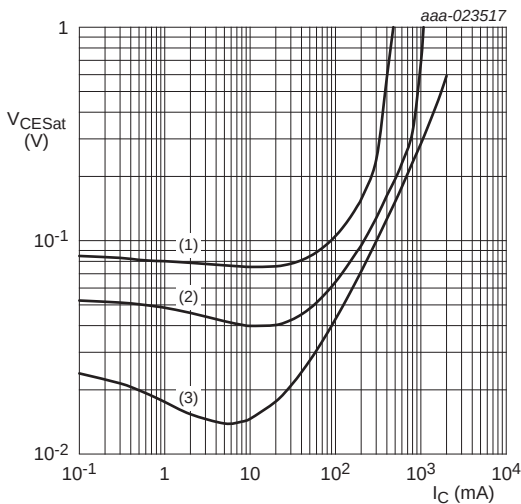
- $I_C/I_B = 10$
- (1)  $T_{amb} = -55^\circ\text{C}$
  - (2)  $T_{amb} = 25^\circ\text{C}$
  - (3)  $T_{amb} = 100^\circ\text{C}$

Fig 12. Base-emitter saturation voltage as a function of collector current; typical values



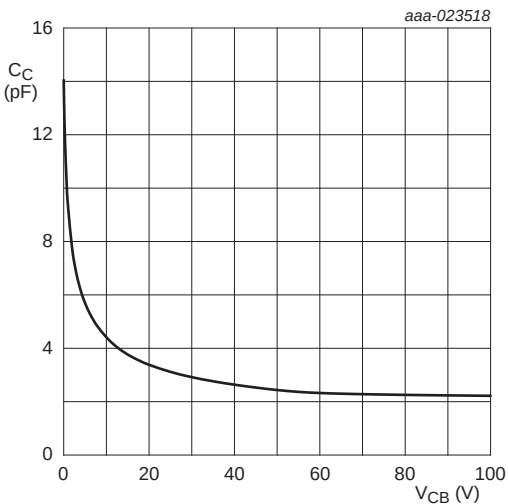
- $I_C/I_B = 10$
- (1)  $T_{amb} = 100^\circ\text{C}$
  - (2)  $T_{amb} = 25^\circ\text{C}$
  - (3)  $T_{amb} = -55^\circ\text{C}$

Fig 13. Collector-emitter saturation voltage as a function of collector current; typical values



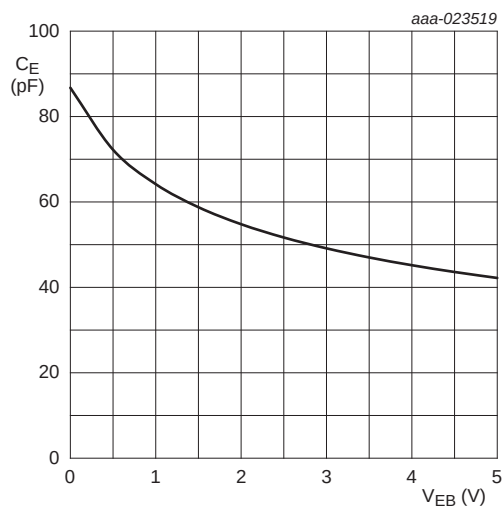
- $T_{amb} = 25^\circ\text{C}$
- (1)  $I_C/I_B = 50$
  - (2)  $I_C/I_B = 20$
  - (3)  $I_C/I_B = 5$

Fig 14. Collector-emitter saturation voltage as a function of collector current; typical values



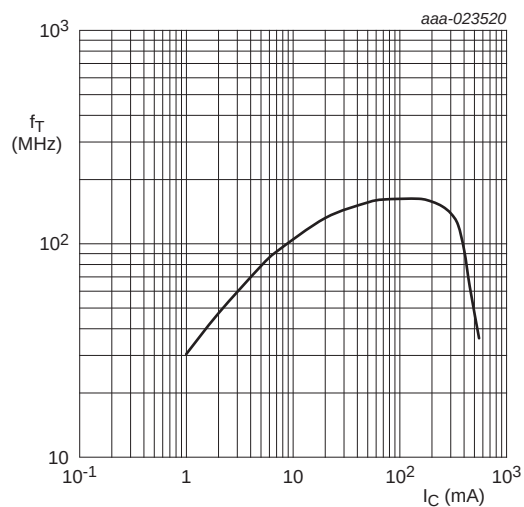
$f = 1\text{ MHz}; T_{amb} = 25^\circ\text{C}$

Fig 15. Collector capacitance as a function of collector-base voltage; typical values



$f = 1$  MHz;  $T_{amb} = 25$  °C

Fig 16. Emitter capacitance as a function of emitter-base voltage; typical values



$V_{CE} = 5$  V;  
 $f = 100$  MHz;  $T_{amb} = 25$  °C

Fig 17. Transition frequency as a function of collector current; typical values

8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

9. Package outline

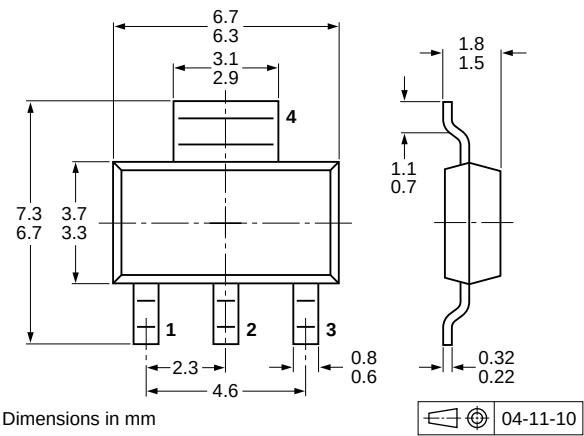


Fig 18. Package outline SOT223 (SC-73)



## 11. Revision history

Table 9. Revision history

| Document ID    | Release date | Data sheet status  | Change notice | Supersedes |
|----------------|--------------|--------------------|---------------|------------|
| BCP56H_SER v.1 | 20161123     | Product data sheet | -             | -          |

## 12. Legal information

### 12.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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## 13. Contact information

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)

## 14. Contents

|           |                                          |           |
|-----------|------------------------------------------|-----------|
| <b>1</b>  | <b>Product profile</b> . . . . .         | <b>1</b>  |
| 1.1       | General description . . . . .            | 1         |
| 1.2       | Features and benefits . . . . .          | 1         |
| 1.3       | Applications . . . . .                   | 1         |
| 1.4       | Quick reference data . . . . .           | 1         |
| <b>2</b>  | <b>Pinning information</b> . . . . .     | <b>2</b>  |
| <b>3</b>  | <b>Ordering information</b> . . . . .    | <b>2</b>  |
| <b>4</b>  | <b>Marking</b> . . . . .                 | <b>2</b>  |
| <b>5</b>  | <b>Limiting values</b> . . . . .         | <b>3</b>  |
| <b>6</b>  | <b>Thermal characteristics</b> . . . . . | <b>5</b>  |
| <b>7</b>  | <b>Characteristics</b> . . . . .         | <b>8</b>  |
| <b>8</b>  | <b>Test information</b> . . . . .        | <b>11</b> |
| 8.1       | Quality information . . . . .            | 11        |
| <b>9</b>  | <b>Package outline</b> . . . . .         | <b>11</b> |
| <b>10</b> | <b>Soldering</b> . . . . .               | <b>12</b> |
| <b>11</b> | <b>Revision history</b> . . . . .        | <b>13</b> |
| <b>12</b> | <b>Legal information</b> . . . . .       | <b>14</b> |
| 12.1      | Data sheet status . . . . .              | 14        |
| 12.2      | Definitions . . . . .                    | 14        |
| 12.3      | Disclaimers . . . . .                    | 14        |
| 12.4      | Trademarks . . . . .                     | 15        |
| <b>13</b> | <b>Contact information</b> . . . . .     | <b>15</b> |
| <b>14</b> | <b>Contents</b> . . . . .                | <b>16</b> |

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## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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